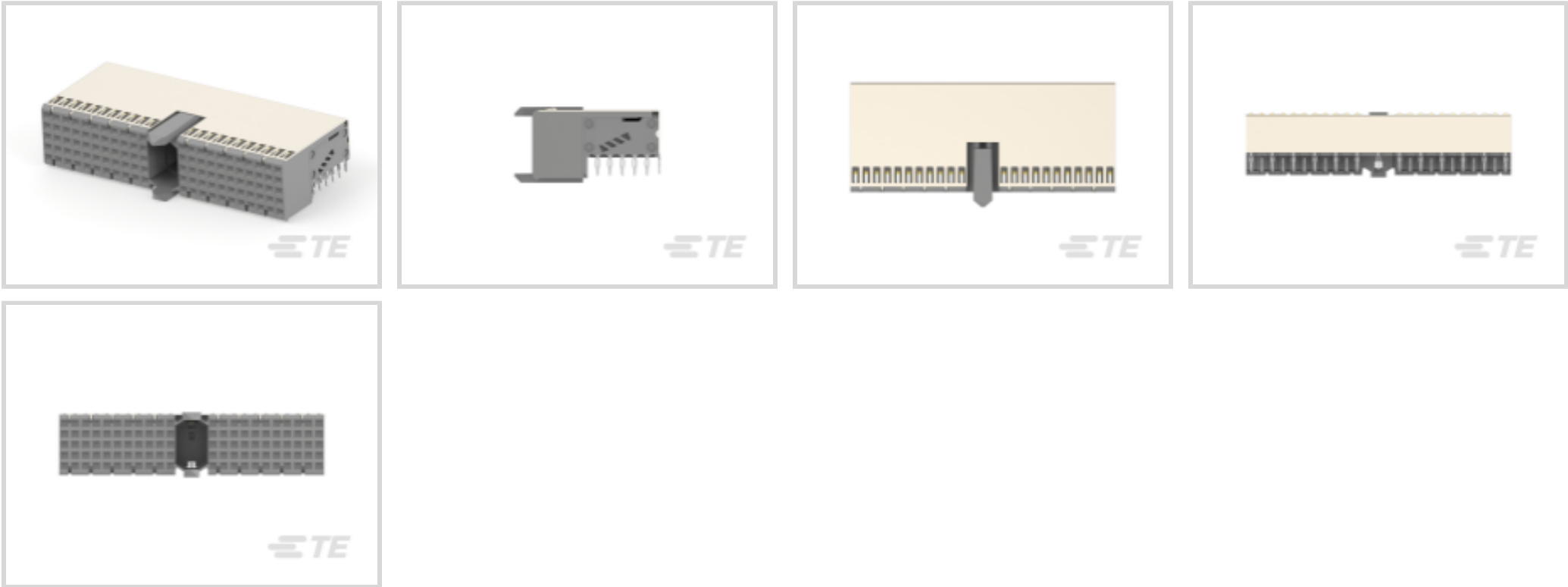




Connectors > PCB Connectors > Backplane Connectors > Hard Metric Connectors



PCB Connector Assembly Type: **PCB Mount Receptacle**

Data Rate: **≤1 Gb/s**

Number of Columns: **25**

Number of Rows: **5**

Backplane Architecture: **Traditional Backplane**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Rows Loaded	A, B, C, D
Number of Columns	25
Number of Rows	5
Backplane Architecture	Traditional Backplane
Number of Positions	110
PCB Mount Orientation	Right Angle

Signal Characteristics

Data Rate	≤1 Gb/s
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Contact Features



CompactPCI Designation	J1/J4
Contact Mating Area Plating Material	Gold or Gold Flash
Contact Current Rating (Max)	1.5 A

Mechanical Attachment

Connector Mounting Type	Board Mount
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Housing Features

Centerline (Pitch)	2 mm[.078 in]
Housing Color	Gray

Usage Conditions

	-55 – 125 °F
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Operation/Application

Circuit Application	Signal
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Industry Standards

AdvancedTCA Specified Product	No
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Packaging Features

Packaging Method	Tray
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as



EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

TE Part # 5352068-1
Z-PACK/A RAF 110P

TE Part # 2391875-1
Z-PACK M.ASSY.154P.EON

Also in the Series | Z-PACK 2mm HM

Backplane Coding Keys(60)

Backplane Connector Housings(4)

Backplane Guide Hardware(37)

Backplane Power Connectors(6)

Board-to-Board Connector Contacts(2)

Hard Metric Backplane Connectors
(269)

Insertion & Extraction Tools(2)

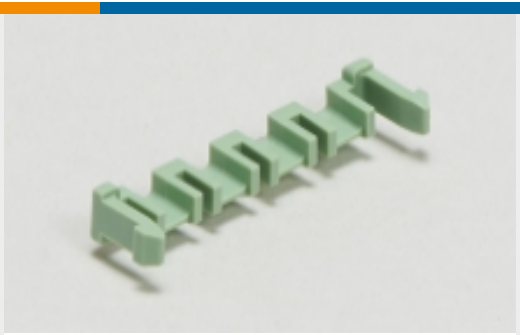
PCB Connector Covers(4)



PCB Connector Shrouds(39)



PCB Ferrules & Shields(19)



PCB Latches, Locks & Retainers(1)



Rectangular Power Connectors(87)

Documents

Product Drawings

Z-PACK/A F-HDR 110P, EON

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2367945-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2367945-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2367945-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Application Specification

English

Application Specification

English